**Product data sheet** 

# 1. General description

AC Thyristor power switch in a TO92 plastic package with self-protective capabilities against low and high energy transients

## 2. Features and benefits

- · Exclusive negative gate triggering
- Full cycle AC conduction
- Very high noise immunity
- · Remote gate separates the gate driver from the effects of the load current
- · Safe clamping of low energy over-voltage transients
- Self-protective turn-on during high energy voltage transients
- · High voltage capability

# 3. Applications

- Fan motor circuits
- Pump motor circuits
- · Lower-power highly inductive, resistive and safety loads

## 4. Quick reference data

#### Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Absolute	maximum rating					
$V_{DRM}$	repetitive peak off-state voltage		-	-	800	V
I <sub>T(RMS)</sub>	RMS on-state current	full sine wave; T <sub>lead</sub> ≤ 75 °C; Fig 1; Fig 2; Fig 3	-	-	0.8	А
Static ch	aracteristics					
I <sub>GT</sub>	gate trigger current	$V_D = 12 \text{ V; } I_T = 0.1 \text{ A; LD+ G-;}$ $T_j = 25 \text{ °C; } Fig. 8$	1	-	10	mA
		$V_D = 12 \text{ V; } I_T = 0.1 \text{ A; LD- G+;}$ $T_j = 25 \text{ °C; } Fig. 8$	1	-	10	mA

# 5. Pinning information

### **Table 2. Pinning information**

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	CM	common		LD 
2	G	gate		G <b>⊸</b>
3	LD	load		CM 001aaj924

# 6. Ordering information

## **Table 3. Ordering information**

Type number	Package Name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date
ACT108-800E	TO92	ACT108-800EEP	Bulk, 412	1000	SOT54 Straight lead	14-Nov-2013
ACT108-800E	TO92	ACT108-800EQP	Reel, 116	2000	SOT54 wide pitch	14-Nov-2013
ACT108-800E	TO92	ACT108-800EML	Ammo, 126	2000	SOT54 wide pitch	14-Nov-2013

# 7. Marking

### Table 4. Marking codes

Type number	Marking codes
ACT108-800E	108-8E

# 8. Limiting values

#### **Table 5. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{DRM}$	repetitive peak off-state voltage		-	800	V
I <sub>T(RMS)</sub>	RMS on-state current	full sine wave; T <sub>lead</sub> ≤ 75 °C; Fig 1; Fig 2; Fig 3	-	8.0	А
I <sub>TSM</sub>	non-repetitive peak on- state current	full sine wave; $T_{j(init)} = 25 \text{ °C}$ ; $t_p = 20 \text{ ms}$ ; Fig 4; Fig 5	-	13	А
		full sine wave; $T_{j(init)}$ = 25 °C; $t_p$ = 16.7 ms	-	14.3	А
l <sup>2</sup> t	I <sup>2</sup> t for fusing	t <sub>p</sub> = 10 ms; sine-wave pulse	-	0.84	A <sup>2</sup> s
dl <sub>⊤</sub> /dt	rate of rise of on-state current	I <sub>G</sub> = 20 mA	-	100	A/µs
I <sub>GM</sub>	peak gate current	t <sub>p</sub> = 20 us	-	1	А
$V_{GM}$	peak gate voltage	positive applied gate voltage	-	15	V
$P_{G(AV)}$	average gate power	over any 20ms period	-	0.1	W
T <sub>stg</sub>	storage temperature		-40	150	°C
T <sub>j</sub>	junction temperature		-	125	°C
$V_{PP}$	peak pulse voltage	T <sub>j</sub> = 25°C; non-repetitive, off-state; ten pulses on each voltage polarity; 20s or more between successive pulses; Fig 6	-	2.5	kV

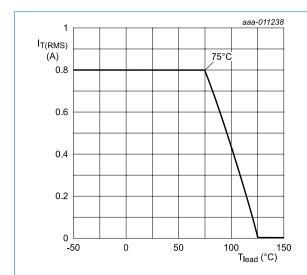
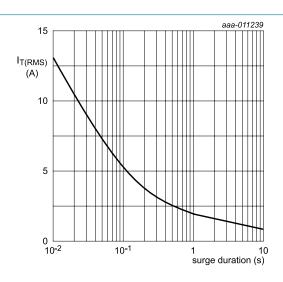


Fig. 1. RMS on-state current as a function of lead temperature; maximum values

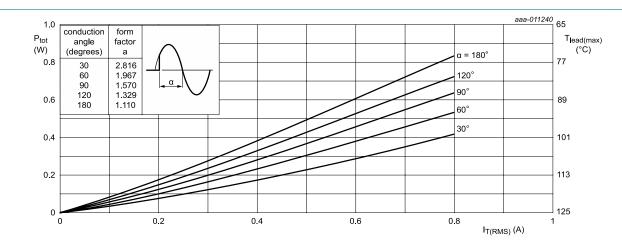


 $f = 50 \text{ Hz}; T_{lead} = 75 \text{ }^{\circ}\text{C}$ 

Fig. 2. RMS on-state current as a function of surge duration; maximum values

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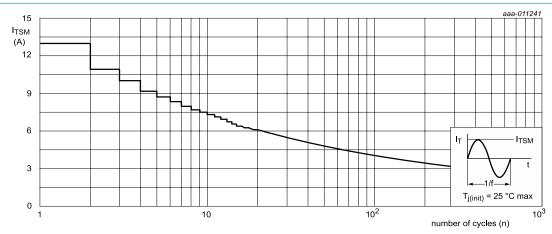
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 $\alpha$  = conduction angle

 $a = form factor = I_{T(RMS)}/I_{T(AV)}$ 

Fig. 3. Total power dissipation as a function of RMS on-state current; maximum values



f = 50 Hz

Fig. 4. Non-repetitive peak on-state current as a function of the number of sinusoidal current cycles; maximum values

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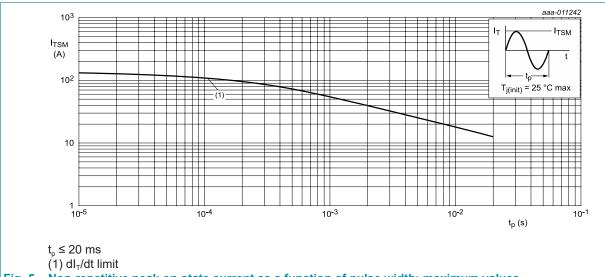


Fig. 5. Non-repetitive peak on-state current as a function of pulse width; maximum values

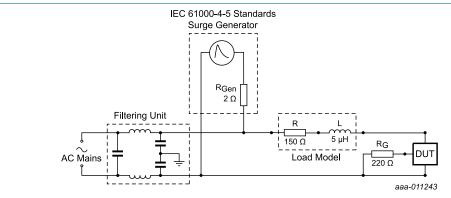
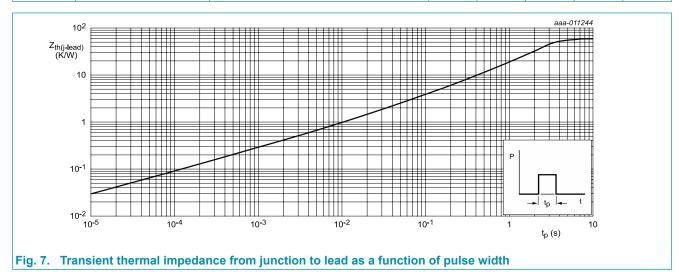


Fig. 6. Test circuit for inductive and resistive loads with conditions equivalent to IEC 61000-4-5

# 9. Thermal characteristics

**Table 6. Thermal characteristics** 

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{\text{th(j-lead)}}$	thermal resistance from junction to lead	full cycle with heatsink compound; Fig. 7	-	-	60	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	full cycle; printed-circuit board mounted; lead length 4mm	-	150	-	K/W



# 10. Characteristics

### **Table 7. Characteristics**

<b>Symbol</b>	Parameter	Conditions	Min	Тур	Max	Unit
Static ch	aracteristics			'		
I <sub>GT</sub>	gate trigger current	$V_D = 12 \text{ V; } I_T = 0.1 \text{ A; LD+ G-;}$ $T_j = 25 \text{ °C; } Fig. 8$	1	-	10	mA
		$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; \text{ LD- G-};$ $T_j = 25 \text{ °C}; \text{ Fig. 8}$	1	-	10	mA
I <sub>L</sub>	latching current	$V_D = 12 \text{ V; } I_G = 0.1 \text{ A; LD+ G-;}$ $T_j = 25 \text{ °C; } Fig. 9$	-	-	25	mA
		V <sub>D</sub> = 12 V; I <sub>G</sub> = 0.1 A; LD- G-; T <sub>I</sub> = 25 °C; <u>Fig. 9</u>	-	-	20	mA
I <sub>H</sub>	holding current	V <sub>D</sub> = 12 V; T <sub>j</sub> = 25 °C; <u>Fig. 10</u>	-	-	20	mA
V <sub>T</sub>	on-state voltage	I <sub>T</sub> = 1.1 A; T <sub>j</sub> = 25 °C; <u>Fig. 11</u>	-	-	1.3	V
$V_{GT}$	gate trigger voltage	$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; T_j = 25 \text{ °C};$ Fig. 12	-	-	1	V
		V <sub>D</sub> = 400 V; I <sub>T</sub> = 0.1 A; T <sub>j</sub> = 125 °C	0.15	-	-	V
I <sub>D</sub>	off-state current	V <sub>D</sub> = 800 V; T <sub>j</sub> = 25 °C	-	-	2	uA
		V <sub>D</sub> = 800 V; T <sub>j</sub> = 125 °C	-	-	0.2	mA
V <sub>CL</sub>	clamping voltage	$I_{CL} = 0.1 \text{ mA}; t_p = 1 \text{ ms}; T_j \le 25 \text{ °C};$	850	-	-	V
Dynamic	characteristics		'	,		'
dV <sub>D</sub> /dt	rate of rise of off-state voltage $V_{DM} = 536 \text{ V}; T_j = 125 \text{ °C}; (V_{DM} = 67\% \text{ of } V_{DRM}); exponential waveform; gate open circuit; Fig. 13$		500	-	-	V/µs
dI <sub>com</sub> /dt	rate of change of commutating current	$V_D = 400 \text{ V; } T_j = 125 \text{ °C; } I_{T(RMS)} = 0.8$ A; $dV_{com}/dt = 20 \text{ V/}\mu\text{s; } (\text{snubberless condition}); gate open circuit; Fig. 14; Fig. 15$	0.5	-	-	A/ms

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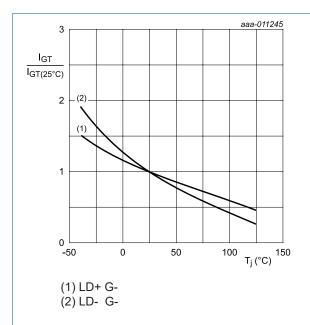
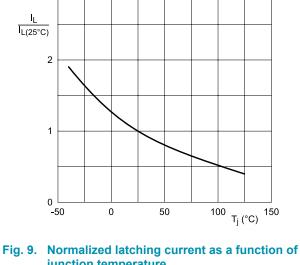


Fig. 8. Normalized gate trigger current as a function of junction temperature



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junction temperature

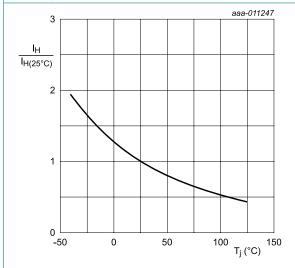
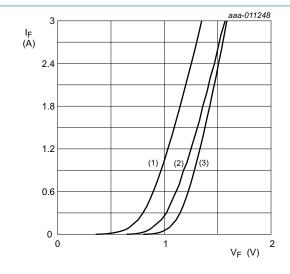


Fig. 10. Normalized holding current as a function of junction temperature



 $V_0 = 0.967 \text{ V}; R_s = 0.225 \Omega$ (1) T<sub>i</sub> = 125 °C; typical values (2) T<sub>i</sub> = 125 °C; maximum values (3)  $T_i = 25$  °C; maximum values

Fig. 11. On-state current as a function of on-state voltage

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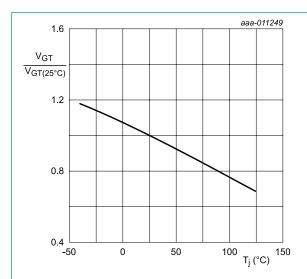
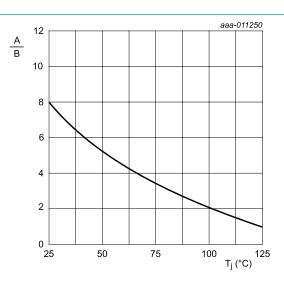
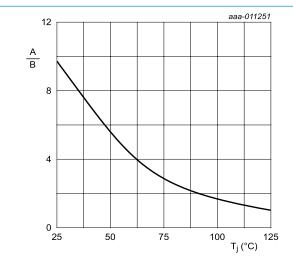


Fig. 12. Normalized gate trigger voltage as a function of junction temperature



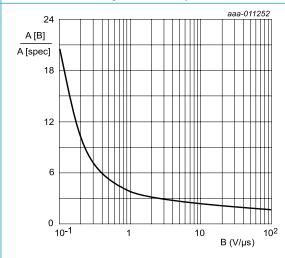
A =  $dV_D/dt$  at condition  $T_j$  °C B =  $dV_D/dt$  at condition  $T_j$  [125] °C

Fig. 13. Normalized rate of rise of off-state voltage as a function of junction temperature



A =  $dI_{com}/dt$  at condition  $T_j$  °C B =  $dI_{com}/dt$  at condition  $T_j$  [125] °C  $V_D$  = 400 V

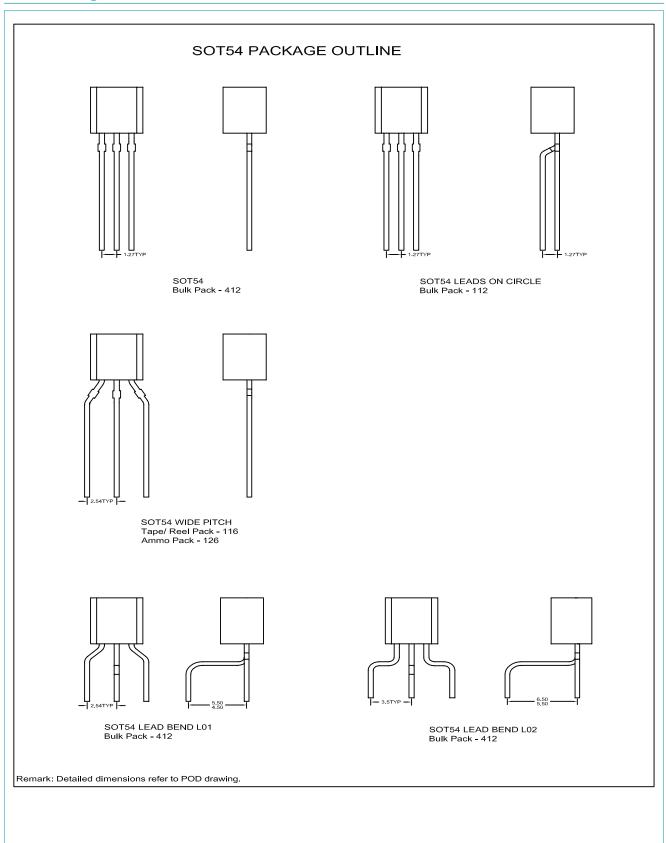
Fig. 14. Normalized critical rate of rise of commutating current as a function of junction temperature



A [B] =  $dI_{com}/dt$  at condition B,  $dV_{com}/dt$ A [spec] is the data sheet value for  $dI_{com}/dt$ turn-off time is less than 20 ms

Fig. 15. Normalized critical rate of change of commutating current as a function of critical rate of change of commutating d voltage; minimum values

# 11. Package outline



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#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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# **ACT108-800E**

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